



DMNH6042SSD

60V DUAL N-CHANNEL 175°C MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _C = +25°C
00) (50mΩ @ V _{GS} = 10V	16.7A
60V	65mΩ @ V _{GS} = 4.5V	14.6A

Description and Applications

This new generation MOSFET is designed to minimize the on-state resistance R_{DS(ON)}, yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

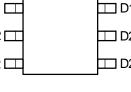
- Engine Management Systems
- **Body Control Electronics**
- **DC-DC Converters**



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SO-8

Top View



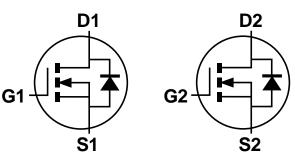
Top View Pin Configuration

Features and Benefits

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- Low R_{DS(ON)} Minimizes Power Losses
- Low Q_g Minimizes Switching Losses Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- An Automotive-Compliant Part is Available Under Separate Datasheet (DMNH6042SSDQ)

Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.076 grams (Approximate)



Equivalent Circuit

Ordering Information (Note 4)

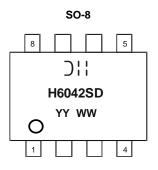
[Part Number	Case	Packaging		
	DMNH6042SSD-13	SO-8	2,500/Tape & Reel		
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.					

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



) | | = Manufacturer's Marking H6042SD = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 16 = 2016) WW = Week (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage	V _{DSS}	60	V		
Gate-Source Voltage	V _{GSS}	±20	V		
	Steady State	T _A = +25°C T _A = +70°C	ID	5.3 4.4	А
Continuous Drain Current (Note 6) $V_{GS} = 10V$	Steady State	T _C = +25°C T _C = +100°C	ID	16.7 14	А
Pulsed Drain Current (10µs pulse, duty cycle = 1%)	I _{DM}	35	А		
Maximum Continuous Body Diode Forward Current	ls	2.3	А		
Avalanche Current (Note 7) L = 10mH	I _{AS}	3.5	А		
Avalanche Energy (Note 7) L = 10mH			E _{AS}	65	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Units	
Total Power Dissipation (Note 5)		PD	1.5	W	
Thermal Desistance, lunction to Ambient (Note 5)	Steady State	D	100	°C/W	
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	R _{0JA}	61	C/VV	
Total Power Dissipation (Note 6)		PD	2.1	W	
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	D	72		
memai Resistance, Junction to Ambient (Note 6)	t<10s	R _{0JA}	44	°C/W	
Thermal Resistance, Junction to Case (Note 6)	R _{θJC}	7.25			
Operating and Storage Temperature Range		T _{J.} T _{STG}	-55 to +175	°C	

Electrical Characteristics (@TA= +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Turn	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)	Symbol	IVIIII	Тур	Widx	Unit	Test Condition	
Drain-Source Breakdown Voltage	BV _{DSS}	60	_	_	V	V _{GS} = 0V, I _D = 250µA	
Zero Gate Voltage Drain Current $T_J = +25^{\circ}C$	IDSS	_	_	1	μA	$V_{DS} = 60V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	—	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)						<u> </u>	
Gate Threshold Voltage	V _{GS(TH)}	1.0	—	3.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance		_	34	50	mΩ	V _{GS} = 10V, I _D = 5.1A	
	R _{DS(ON)}	_	45	65	11152	$V_{GS} = 4.5V, I_D = 4.4A$	
Diode Forward Voltage	V _{SD}	_	0.8	1.2	V	$V_{GS} = 0V, I_{S} = 2.6A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss		584	-	pF		
Output Capacitance	Coss		83	—	pF	$V_{DS} = 25V, V_{GS} = 0V,$ - f = 1.0MHz	
Reverse Transfer Capacitance	Crss		24	-	pF	1 - 1.000112	
Gate Resistance	Rg	_	3.8	—	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	—	4.2	—	nC		
Total Gate Charge (V _{GS} = 10V)	Qq	_	8.8	—	nC		
Gate-Source Charge	Q _{gs}	_	1.8	—	nC	$V_{DS} = 44V, I_D = 5.2A$	
Gate-Drain Charge	Q _{gd}	_	1.8	—	nC		
Turn-On Delay Time	t _{D(ON)}	_	3.4	_	ns		
Turn-On Rise Time	t _R	_	1.9	_	ns	V _{GS} = 10V, V _{DS} = 30V,	
Turn-Off Delay Time	t _{D(OFF)}		10.1	_	ns	$R_G = 6\Omega, I_D = 1A$	
Turn-Off Fall Time	tF	_	4.5	_	ns	7	
Body Diode Reverse Recovery Time	t _{RR}		12.9	—	ns	I _F = 2.6A, di/dt = 100A/µs	
Body Diode Reverse Recovery Charge	Q _{RR}	_	5.4	—	nC		

Notes:

Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

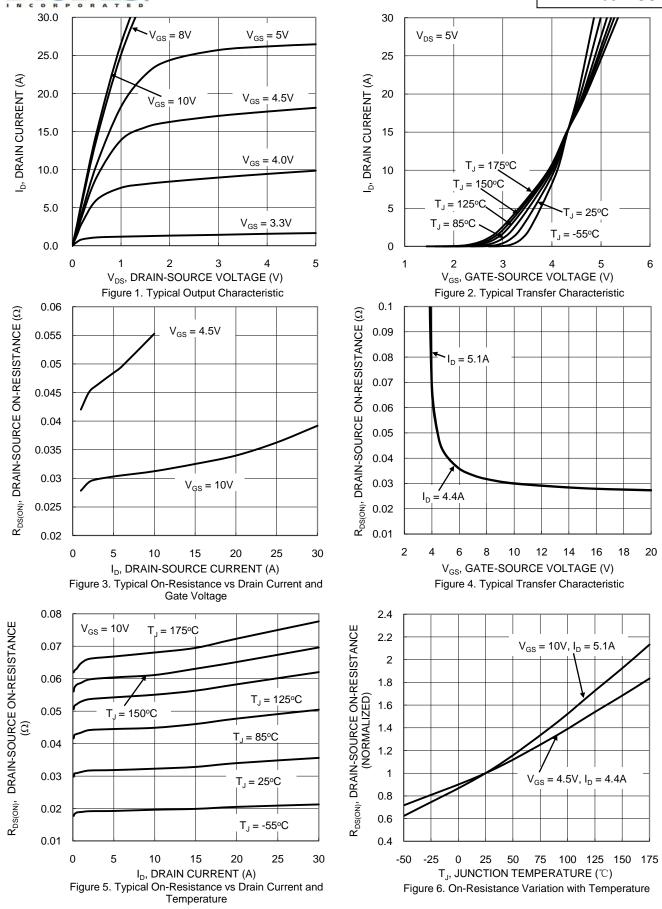
7. I_{AS} and E_{AS} rating are based on low frequency and duty cycles to keep $T_J = +25^{\circ}C$.

8. Short duration pulse test used to minimize self-heating effect.

9. Guaranteed by design. Not subject to product testing.

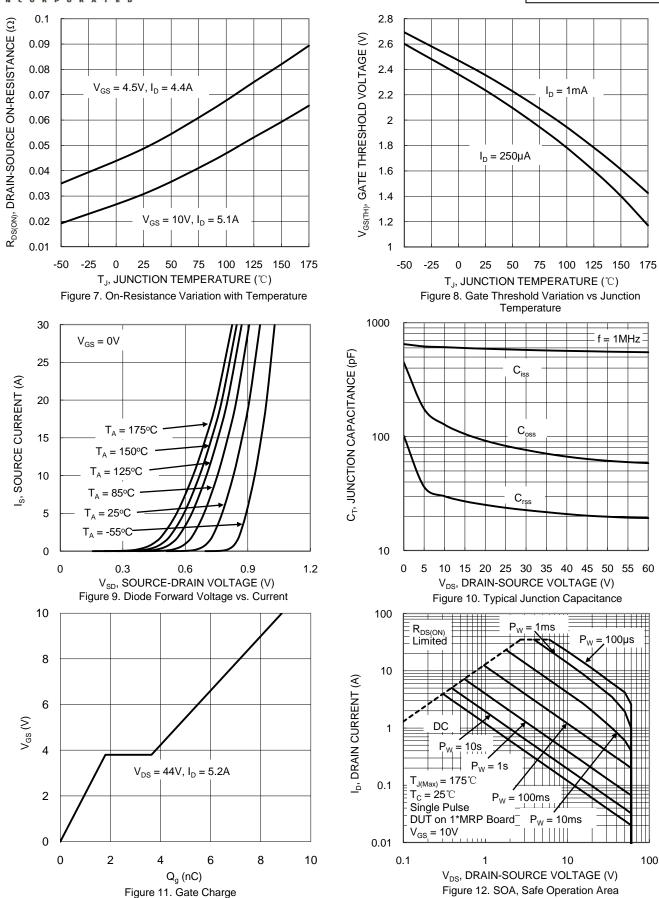


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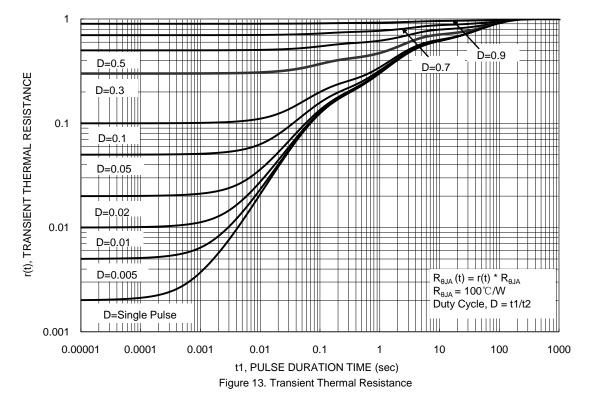




DMNH6042SSD









Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

Particular de la construction de

	SO-8						
Dim	Min	Max	Тур				
Α	1.40	1.50	1.45				
A1	0.10	0.20	0.15				
b	0.30	0.50	0.40				
С	0.15	0.25	0.20				
D	4.85	4.95	4.90				
Е	5.90	6.10	6.00				
E1	3.80	3.90	3.85				
E0	3.85	3.95	3.90				
е			1.27				
h	-		0.35				
L	0.62	0.82	0.72				
Q	0.60	0.70	0.65				
All	All Dimensions in mm						

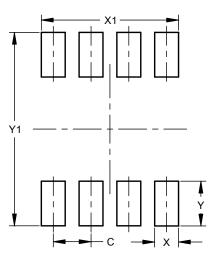
Suggested Pad Layout

D

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8

SO-8



Dimensions	Value (in mm)			
С	1.27			
Х	0.802			
X1	4.612			
Y	1.505			
Y1	6.50			



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